

# **CALL FOR PAPERS**

The 7<sup>th</sup> IEEE International Conference on Sensing, Diagnostics, Prognostics, and Control (**SDPC 2024**) will be held in **Shijiazhuang**, **China**, on **July 26-28**, **2024**. SDPC 2024 will be held together by Shijiazhuang Tiedao University, IEEE Beijing Section, Chongqing University of Posts and Telecommunications, China Electronic Product Reliability and Environmental Testing Research Institute, Chongqing Jiaotong University, Beijing Jiaotong University, Chongqing Technology and Business University, and CJA (Elsevier). SDPC 2024 will offer opportunities to bring the experts from both academic and industrial fields together to attain synergetic exchanges of ideas and practices.

Prospective authors are invited to submit high-quality original papers for presentation at the conference. Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. Outstanding papers with sufficient extensions will be recommended to prestigious International Journals including *CJA* and *CJME*. SDPC 2024 will provide Best Paper Awards (Certificates & Cash) for student authors and non-student authors.

# **CONFERENCE TOPICS**

Authors are invited to submit papers of relevance to the SDPC Conference. The SDPC topics and applications include but are not limited to:

- Advanced sensing and data acquisition
- Smart sensing and sensor networks
- □ Flexible electronic device
- Uncertainty representation and management
- $\hfill \Box$  Diagnostics and prognostics algorithms
- Prognostics for electronics systems
- Prognostics for energy storage and smart grid
- System safety and reliability
- □ Intelligent transportation system

- □ Intelligent materials, structures and systems
- Intelligent predictive control systems
- Fault tolerant control methods
- Intelligent bionic robot
- Industrial Internet technology
- Communication network and test technology
- Computer network and information security
- Intelligent perception and cognition
- Electromagnetic radiation protection technology

















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## **IMPORTANT DATES**

Draft Full Paper Due May 25, 2024

Linghui Meng, CEPREI, China

Notification of Draft Paper Acceptance June 25, 2024 (Extended)

Final Manuscript Due

July 5, 2024 (Extended)

Author Registration Deadline July 5, 2024 (Extended)

**Conference Dates** 

July 26-28, 2024